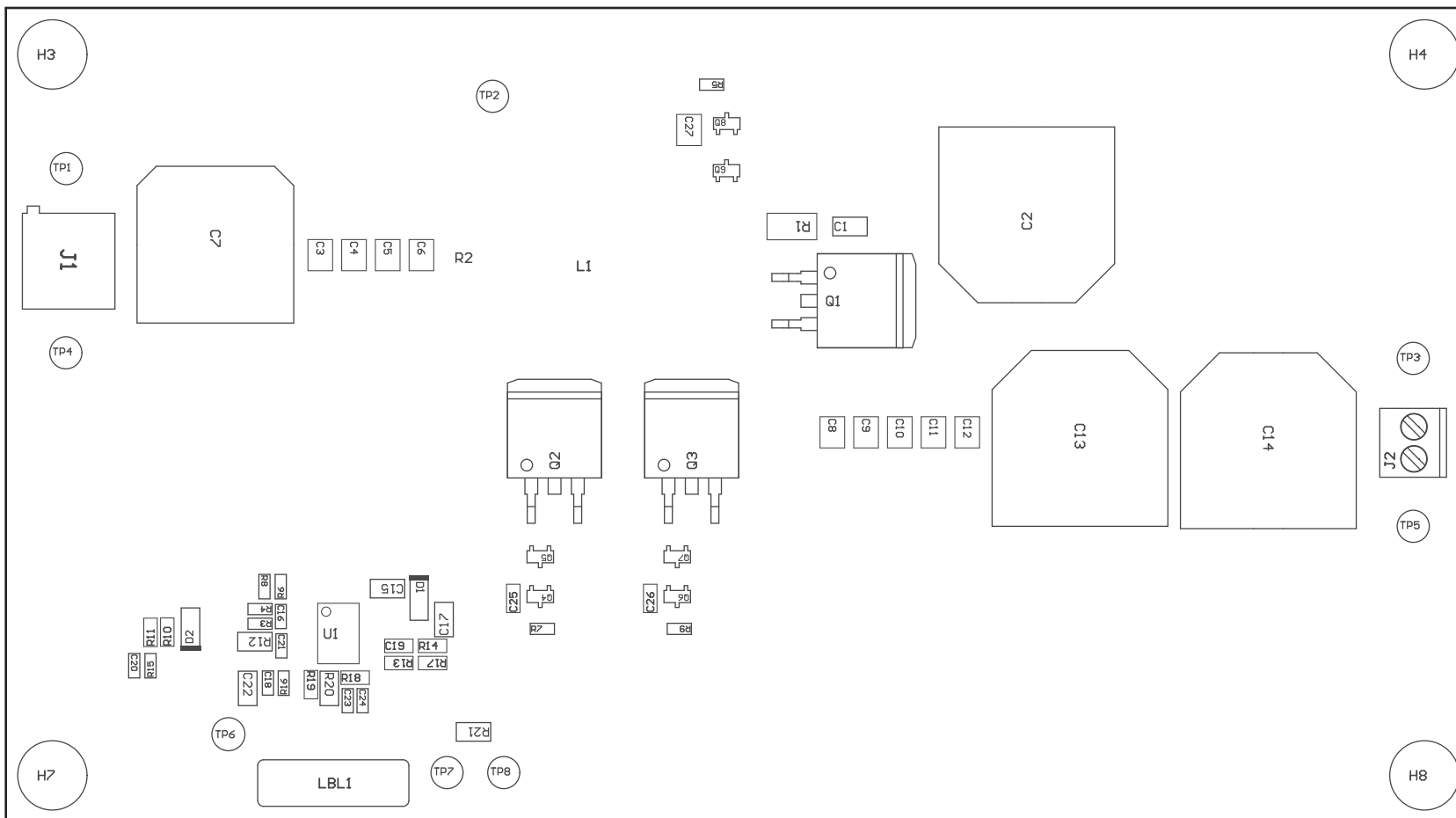


TABLE 1

Variant	Label text
001	ChangeMe1
002	ChangeMe1

- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: PMP7950 rev1B REV: B	SUN REV: Not In VersionControl
IGNORE ->		
PLOT NAME = Top Assembly Drawing	GENERATED : 9/23/2015 11:48:15 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP7950 rev1B REV: B	SUN REV: Not In VersionControl
IGNORE ->		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/23/2015 11:48:16 AM	TEXAS INSTRUMENTS

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